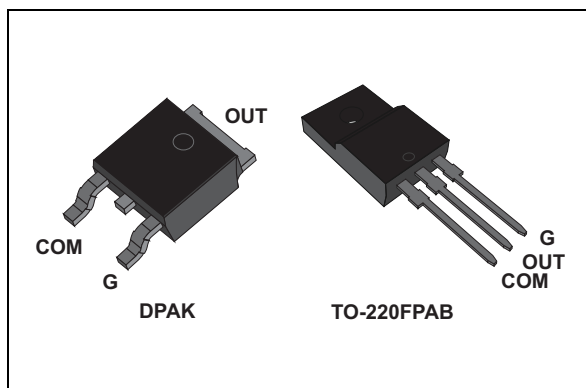


Overvoltage protected AC switch

Datasheet - production data



Description

The ACST4 series belongs to the ACS / ACST power switch family. This high performance device is suited to home appliances or industrial systems and drives loads up to 4 A.

This ACST4 switch embeds a Triac structure with a high voltage clamping device to absorb the inductive turn-off energy and withstand line transients such as those described in the IEC 61000-4-5 standards. The ACST410 needs a low gate current to be activated ($I_{GT} < 10$ mA) and still shows a high electrical noise immunity complying with IEC standards such as IEC 61000-4-4 (fast transient burst test).

Features

- Triac with overvoltage protection
- Low I_{GT} (< 10 mA) or high immunity ($I_{GT} < 35$ mA) version
- High noise immunity: static $dV/dt > 1000$ V/ μ s
- TO-220FPAB insulated package:
 - complies with UL standards (File ref : E81734)
 - insulation voltage: 2000 V_{RMS}

Benefits

- Enables equipment to meet IEC 61000-4-5
- High off-state reliability with planar technology
- Needs no external overvoltage protection
- Reduces the power passive component count
- High immunity against fast transients described in IEC 61000-4-4 standards

Applications

- AC mains static switching in appliance and industrial control systems
- Drive of medium power AC loads such as:
 - Universal motor of washing machine drum
 - Compressor for fridge or air conditioner

Figure 1. Functional diagram

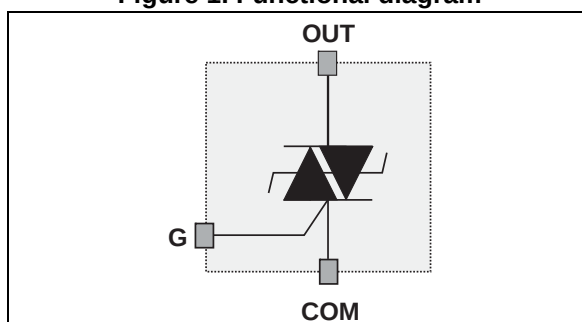


Table 1. Device summary

Symbol	Value	Unit
$I_{T(RMS)}$	4	A
V_{DRM}/V_{RRM}	800	V
$I_{GT}(ACST410)$	10	mA
$I_{GT}(ACST435)$	35	mA

1 Characteristics

Table 2. Absolute maximum ratings (limiting values)

Symbol	Parameter			Value	Unit
$I_{T(RMS)}$	On-state rms current (full sine wave)	TO-220FPAB	$T_c = 102\text{ }^{\circ}\text{C}$	4	A
		DPAK	$T_c = 112\text{ }^{\circ}\text{C}$		
		DPAK with 0.5 cm ² copper	$T_{amb} = 60\text{ }^{\circ}\text{C}$	1	
I_{TSM}	Non repetitive surge peak on-state current (full cycle sine wave, T_j initial = 25 °C)	F = 60 Hz	$t_p = 16.7\text{ ms}$	32	A
		F = 50 Hz	$t_p = 20\text{ ms}$	30	A
I^2t	I^2t Value for fusing		$t_p = 10\text{ ms}$	6	A ² s
di/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$, $t_r = 100\text{ ns}$	F = 120 Hz	$T_j = 125\text{ }^{\circ}\text{C}$	100	A/ μ s
$V_{PP}^{(1)}$	Non repetitive line peak mains voltage ⁽¹⁾		$T_j = 25\text{ }^{\circ}\text{C}$	2	kV
$P_{G(AV)}$	Average gate power dissipation		$T_j = 125\text{ }^{\circ}\text{C}$	0.1	W
P_{GM}	Peak gate power dissipation ($t_p = 20\text{ }\mu$ s)		$T_j = 125\text{ }^{\circ}\text{C}$	10	W
I_{GM}	Peak gate current ($t_p = 20\text{ }\mu$ s)		$T_j = 125\text{ }^{\circ}\text{C}$	1.6	A
T_{stg}	Storage junction temperature range			-40 to +150	$^{\circ}\text{C}$
T_j	Operating junction temperature range			-40 to +125	
T_l	Maximum lead soldering temperature during 10 s (at 3 mm from plastic case)			260	$^{\circ}\text{C}$
$V_{INS(RMS)}$	Insulation RMS voltage (60 seconds)		TO-220FPAB	2000	V

1. According to test described in IEC 61000-4-5 standard and [Figure 18](#)

Table 3. Electrical characteristics ($T_j = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

Symbol	Test conditions	Quadrant		ACST410	ACST435	Unit
$I_{GT}^{(1)}$	$V_{OUT} = 12\text{ V}$, $R_L = 33\text{ }\Omega$	I - II - III	MAX	10	35	mA
V_{GT}	$V_{OUT} = 12\text{ V}$, $R_L = 33\text{ }\Omega$	I - II - III	MAX	1.0	1.1	V
V_{GD}	$V_{OUT} = V_{DRM}$, $R_L = 3.3\text{ k}\Omega$, $T_j = 125\text{ }^{\circ}\text{C}$	I - II - III	MIN	0.2		V
$I_H^{(2)}$	$I_{OUT} = 500\text{ mA}$		MAX	20	25	mA
I_L	$I_G = 1.2 \times I_{GT}$	I - II-III	MAX	40	60	mA
$dV/dt^{(2)}$	$V_{OUT} = 67\% V_{DRM}$ gate open, $T_j = 125\text{ }^{\circ}\text{C}$		MIN	500	1000	V/ μ s
$(di/dt)_c^{(2)}$	without snubber, $T_j = 125\text{ }^{\circ}\text{C}$		MIN		5	A/ms
$(di/dt)_c^{(2)}$	$(dV/dt)_c = 15\text{ V}/\mu\text{s}$, $T_j = 125\text{ }^{\circ}\text{C}$		MIN	2		A/ms
V_{CL}	$I_{CL} = 0.1\text{ mA}$, $t_p = 1\text{ ms}$		MIN	850		V

1. Minimum I_{GT} is guaranteed at 5% of I_{GT} max

2. For both polarities of OUT pin referenced to COM pin

Table 4. Static electrical characteristics

Symbol	Test conditions			Value	Unit
$V_{TM}^{(1)}$	$I_{TM} = 5.6 \text{ A}$, $t_p = 500 \mu\text{s}$	$T_j = 25 \text{ }^\circ\text{C}$	MAX	1.7	V
$V_{TO}^{(1)}$	Threshold voltage	$T_j = 125 \text{ }^\circ\text{C}$	MAX	0.9	V
$R_D^{(1)}$	Dynamic resistance	$T_j = 125 \text{ }^\circ\text{C}$	MAX	110	m Ω
I_{DRM} I_{RRM}	$V_{OUT} = V_{DRM} / V_{RRM}$	$T_j = 25 \text{ }^\circ\text{C}$	MAX	20	μA
		$T_j = 125 \text{ }^\circ\text{C}$		0.5	mA

1. For both polarities of OUT pin referenced to COM pin

Table 5. Thermal resistances

Symbol	Parameter		Value	Unit
$R_{th(j-c)}$	Junction to case for full cycle sine wave conduction	DPAK	2.6	$^\circ\text{C/W}$
		TO-220FPAB	4.6	
$R_{th(j-a)}$	Junction to ambient	TO-220FPAB	60	
		$S_{CU}^{(1)} = 0.5 \text{ cm}^2$ DPAK	70	

1. S_{CU} = copper surface under tab

Figure 2. Maximum power dissipation versus on-state RMS current

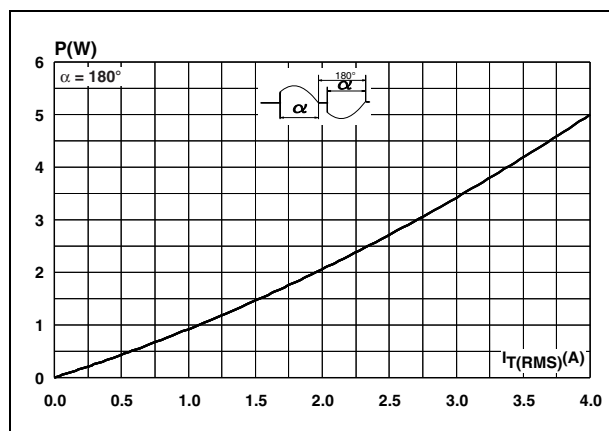


Figure 3. On-state RMS current versus case temperature (full cycle)

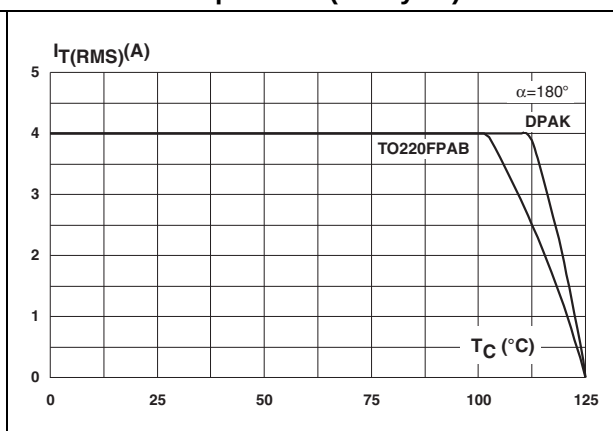


Figure 4. On-state RMS current versus ambient temperature (free air convection, full cycle)

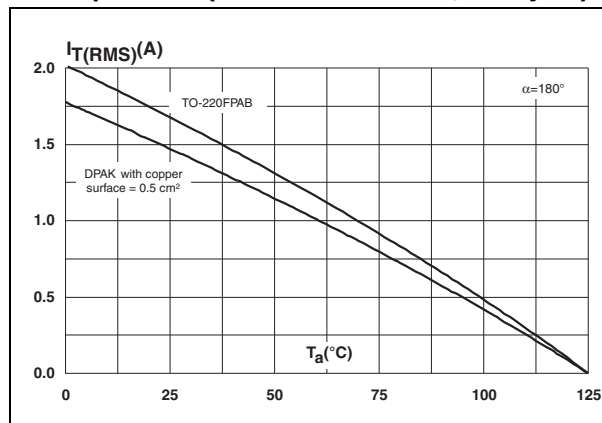


Figure 5. Relative variation of thermal impedance versus pulse duration

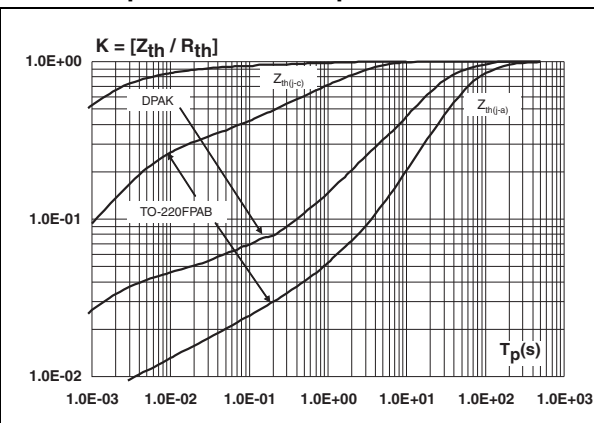


Figure 6. Relative variation of gate trigger current (I_{GT}) and voltage (V_{GT}) versus junction temperature (typical values)

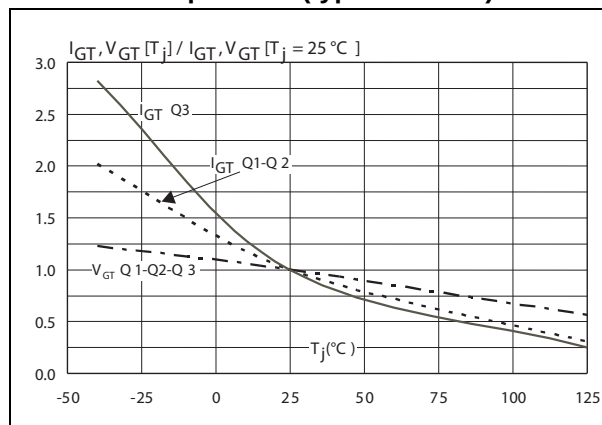


Figure 7. Relative variation of holding current (I_H) and latching current (I_L) versus junction temperature (typical values)

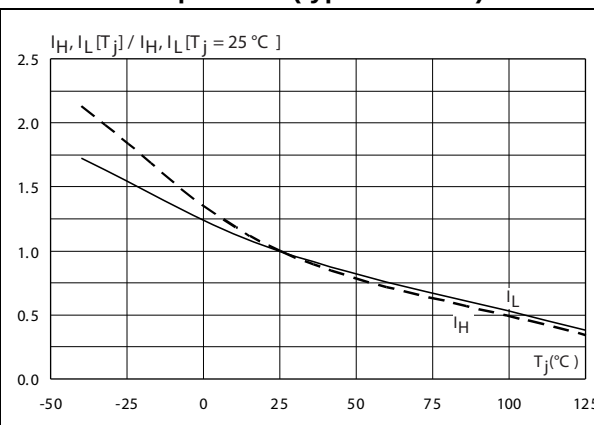


Figure 8. Surge peak on-state current versus number of cycles

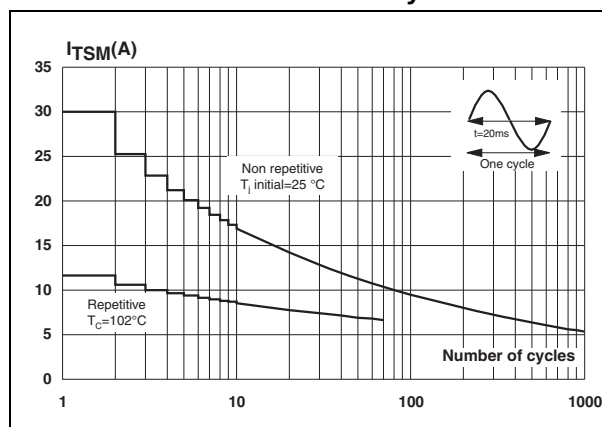


Figure 9. Non repetitive surge peak on-state current versus sinusoidal pulse width

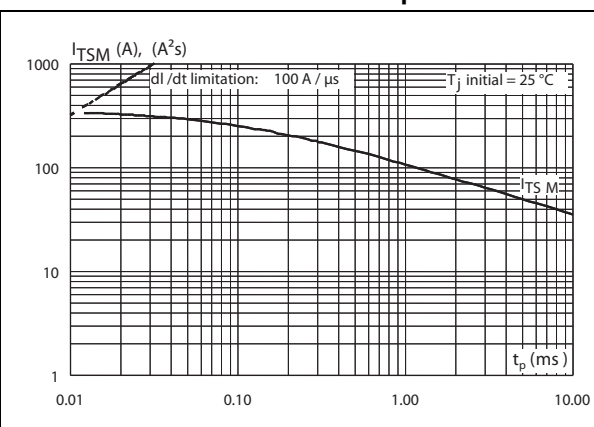


Figure 10. On-state characteristics
(maximum values)

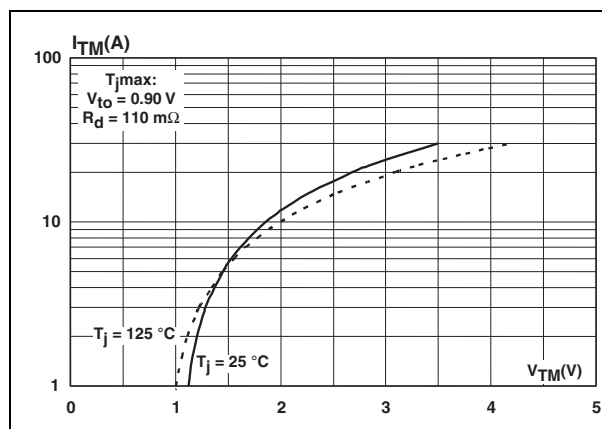


Figure 11. Relative variation of critical rate of decrease of main current $(di/dt)_c$ versus junction temperature

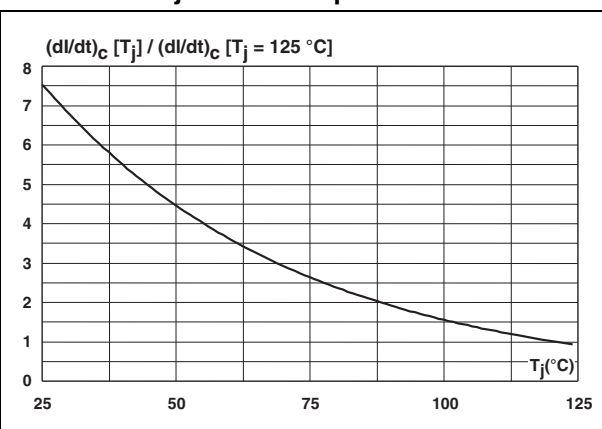


Figure 12. Relative variation of static dV/dt immunity versus junction temperature (gate open)

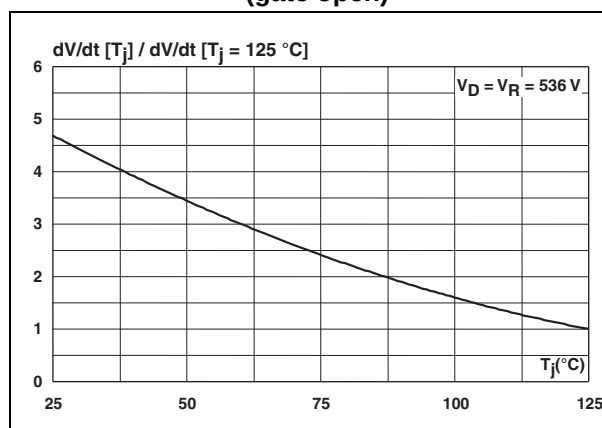


Figure 13. Relative variation of leakage current versus junction temperature

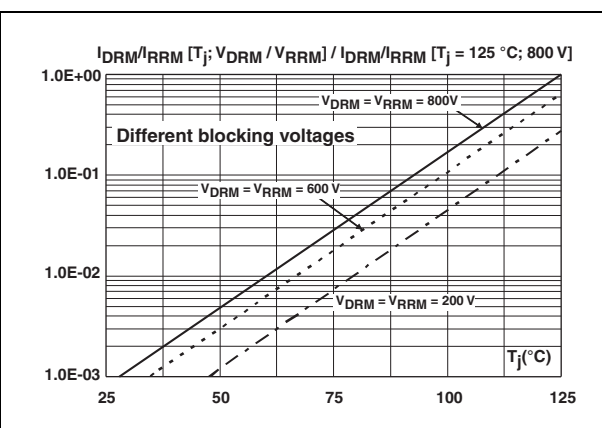


Figure 14. Relative variation of the clamping voltage (V_{CL}) versus junction temperature (minimum values)

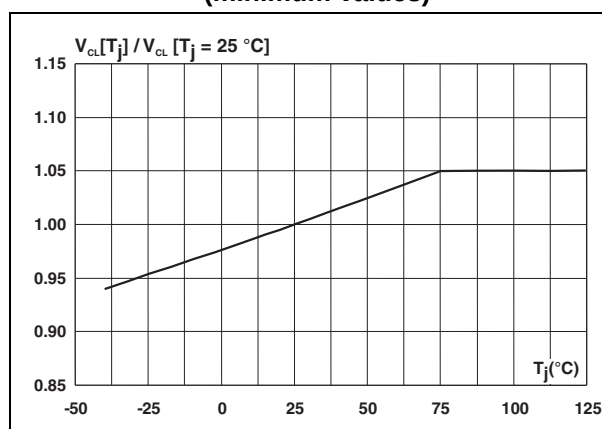
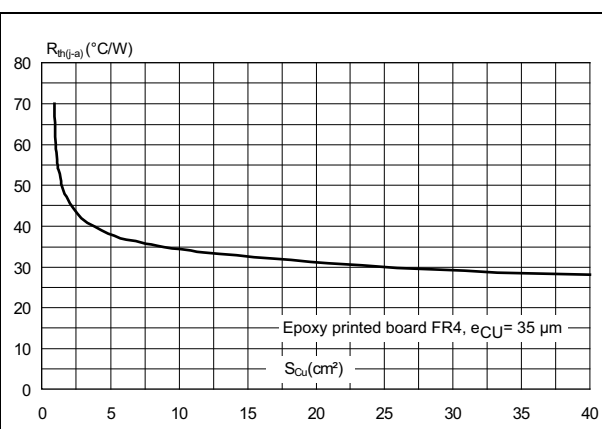


Figure 15. Thermal resistance junction to ambient versus copper surface under tab



2 Application information

2.1 Typical application description

The ACST4 device has been designed to control medium power load, such as AC motors in home appliances. Thanks to its thermal and turn off commutation performances, the ACST4 switch is able to drive an inductive load up to 4 A with no turn off additional snubber. It also provides high thermal performances in static and transient modes such as the compressor inrush current or high torque operating conditions of an AC motor. Thanks to its low gate triggering current level, the ACST4 can be driven directly by an MCU through a simple gate resistor as shown [Figure 16](#) and [Figure 17](#).

Figure 16. Compressor control – typical diagrams

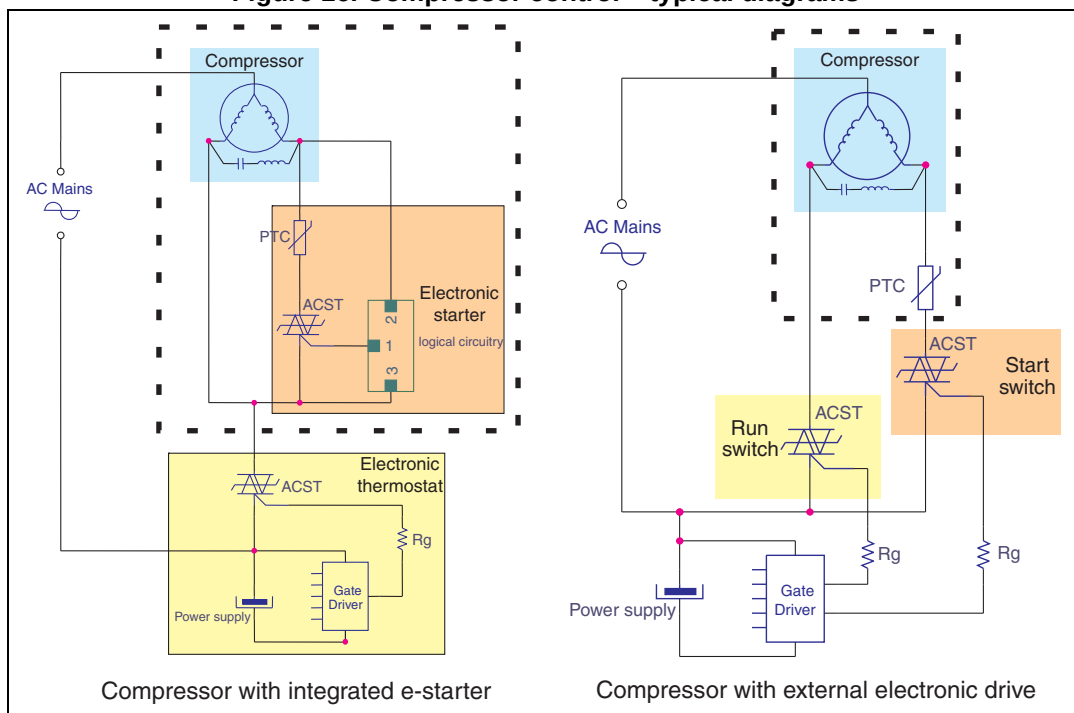
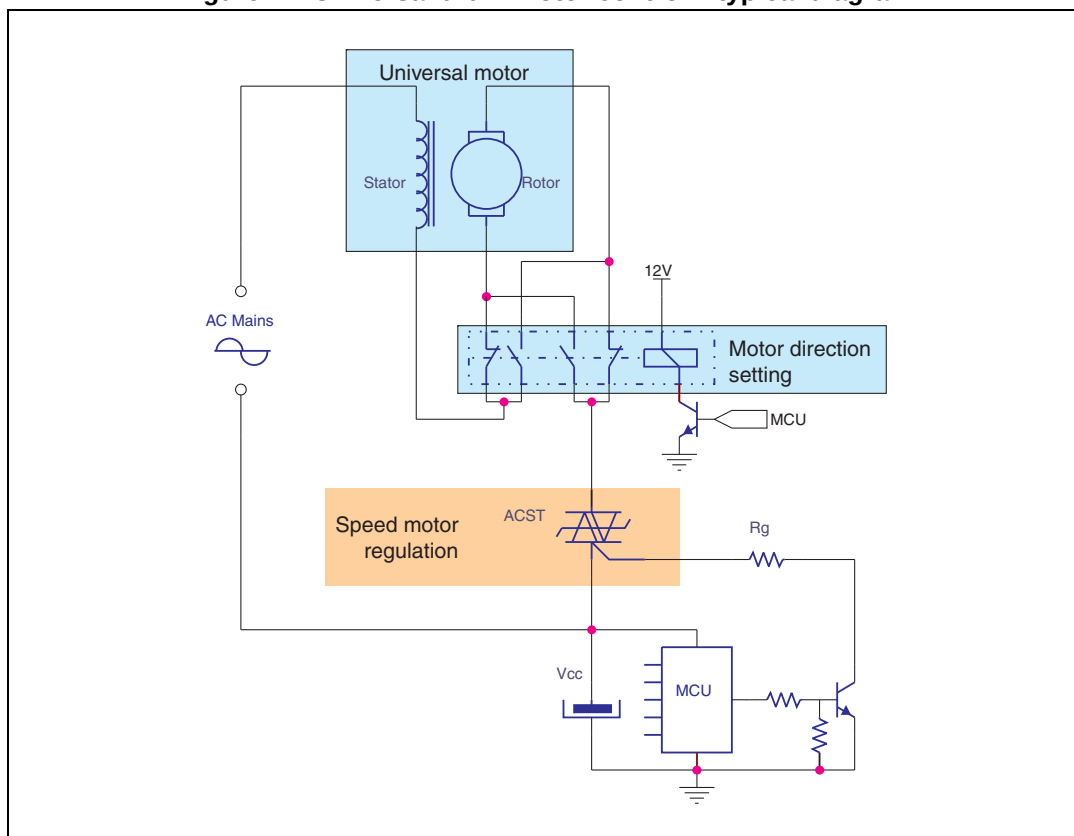


Figure 17. Universal drum motor control – typical diagram



2.2 AC line transient voltage ruggedness

In comparison with standard Triacs, which are not robust against surge voltage, the ACST4 is self-protected against over-voltage, specified by the new parameter V_{CL} . The ACST4 switch can safely withstand AC line transient voltages either by clamping the low energy spikes, such as inductive spikes at switch off, or by switching to the on state (for less than 10 ms) to dissipate higher energy shocks through the load. This safety feature works even with high turn-on current ramp up.

The test circuit of [Figure 18](#) represents the ACST4 application, and is used to stress the ACST switch according to the IEC 61000-4-5 standard conditions. With the additional effect of the load which is limiting the current, the ACST switch withstands the voltage spikes up to 2 kV on top of the peak line voltage. The protection is based on an overvoltage crowbar technology. The ACST4 folds back safely to the on state as shown in [Figure 19](#). The ACST4 recovers its blocking voltage capability after the surge and the next zero current crossing. Such a non repetitive test can be done at least 10 times on each AC line voltage polarity.

Figure 18. Overvoltage ruggedness test circuit for resistive and inductive loads for IEC 61000-4-5 standards

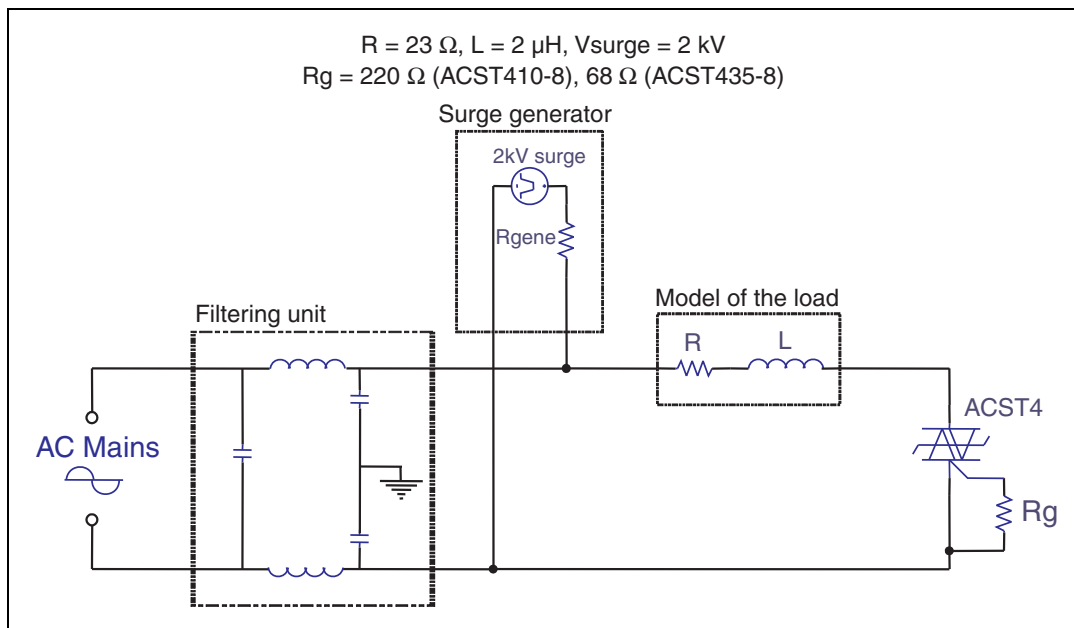
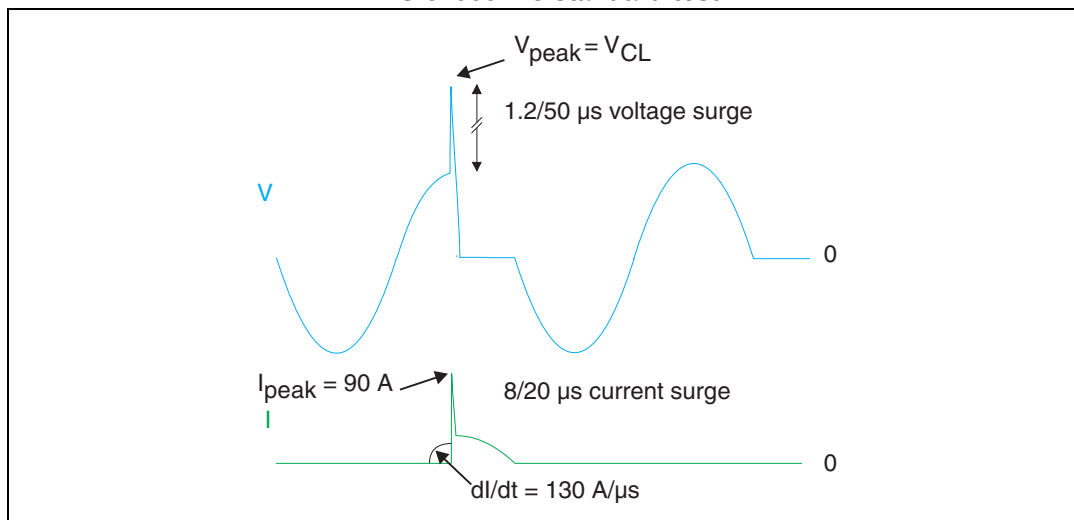


Figure 19. Typical current and voltage waveforms across the ACST4 during IEC 61000-4-5 standard test



3 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque (TO-220FPAB): 0.4 to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Figure 20. TO-220FPAB package outline

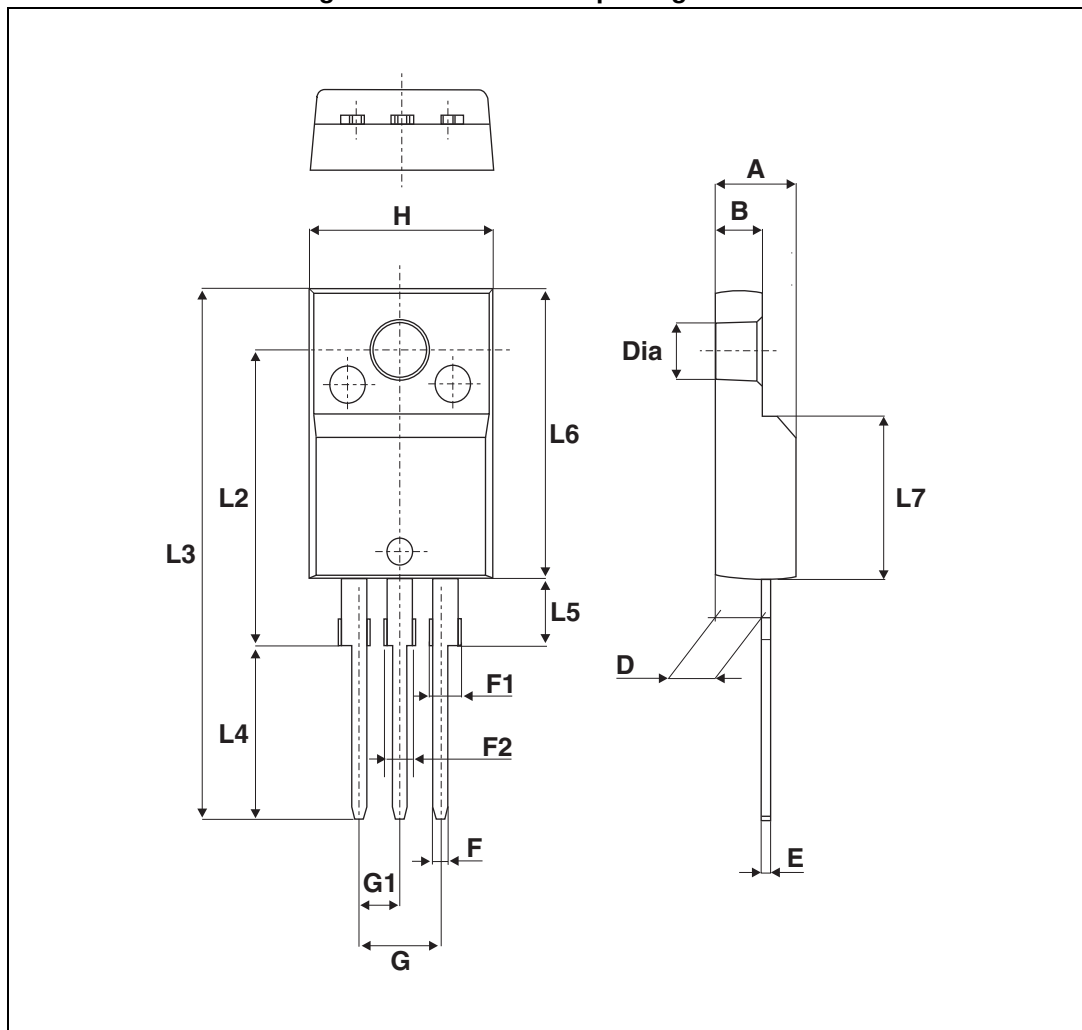
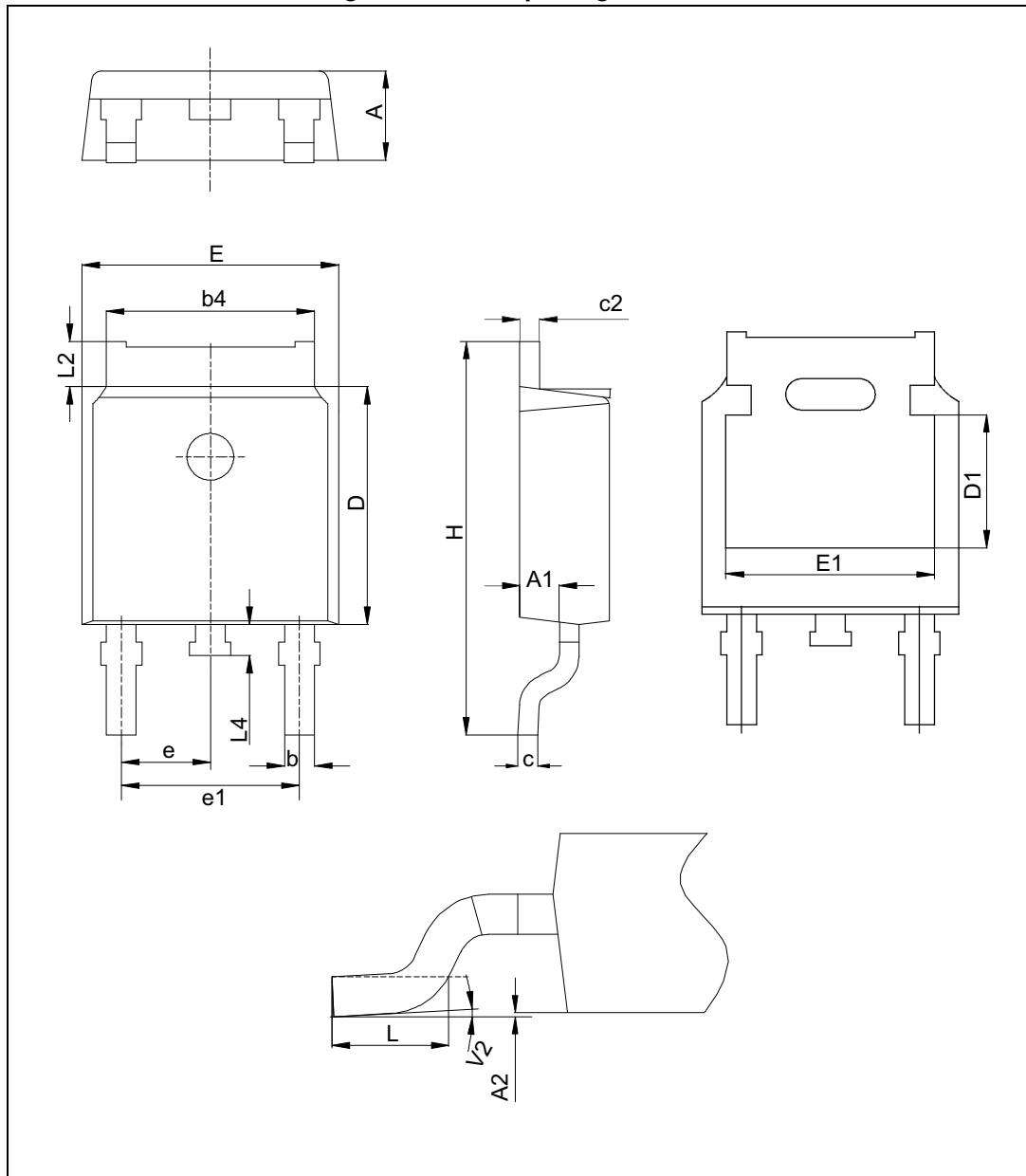


Table 6. TO-220FPAB package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.4		4.6	0.1732		0.1811
B	2.5		2.7	0.0984		0.1063
D	2.5		2.75	0.0984		0.1083
E	0.45		0.70	0.0177		0.0276
F	0.75		1	0.0295		0.0394
F1	1.15		1.70	0.0453		0.0669
F2	1.15		1.70	0.0453		0.0669
G	4.95		5.20	0.1949		0.2047
G1	2.4		2.7	0.0945		0.1063
H	10		10.4	0.3937		0.4094
L2		16			0.6299	
L3	28.6		30.6	1.1260		1.2047
L4	9.8		10.6	0.3858		0.4173
L5	2.9		3.6	0.1142		0.1417
L6	15.9		16.4	0.6260		0.6457
L7	9.00		9.30	0.3543		0.3661
Dia.	3.00		3.20	0.1181		0.1260

Figure 21. DPAK package outline

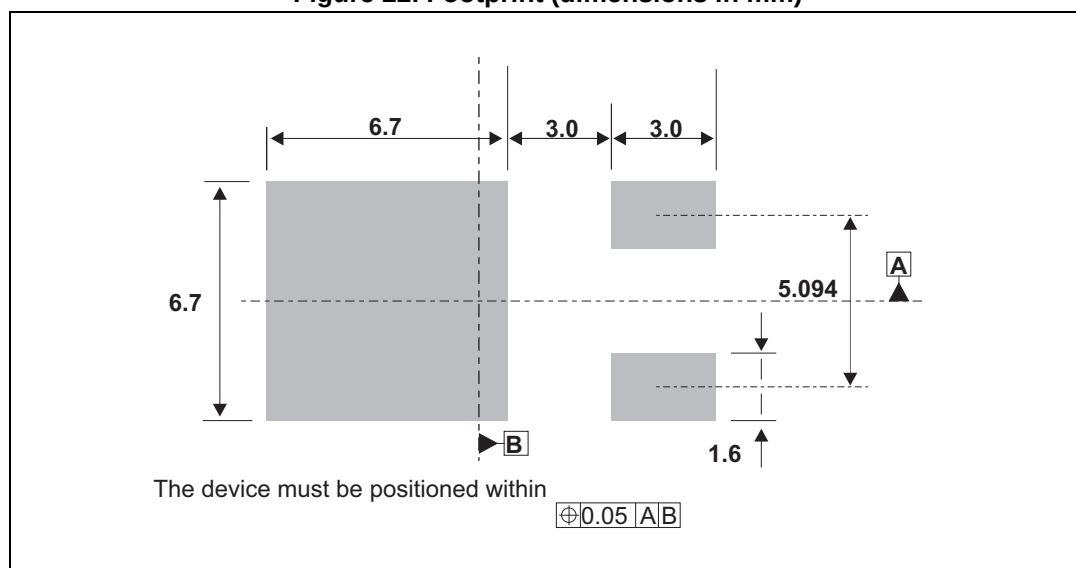


Note: This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

Table 7. DPAK package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.18		2.40	0.0858		0.0945
A1	0.90		1.10	0.0354		0.0433
A2	0.03		0.23	0.0012		0.0091
b	0.64		0.90	0.0252		0.0354
b4	4.95		5.46	0.1949		0.2150
c	0.46		0.61	0.0181		0.0240
c2	0.46		0.60	0.0181		0.0240
D	5.97		6.22	0.2350		0.2449
D1	4.95		5.60	0.1949		0.2205
E	6.35		6.73	0.2500		0.2650
E1	4.32		5.50	0.1701		0.2165
e		2.286			0.0900	
e1	4.40		4.70	0.1732		0.1850
H	9.35		10.40	0.3681		0.4094
L	1.00		1.78	0.0394		0.0701
L2			1.27			0.0500
L4	0.60		1.02	0.0236		0.0402
V2	-8°		8°	-8°		8°

Figure 22. Footprint (dimensions in mm)



4 Ordering information

Figure 23. Ordering information scheme

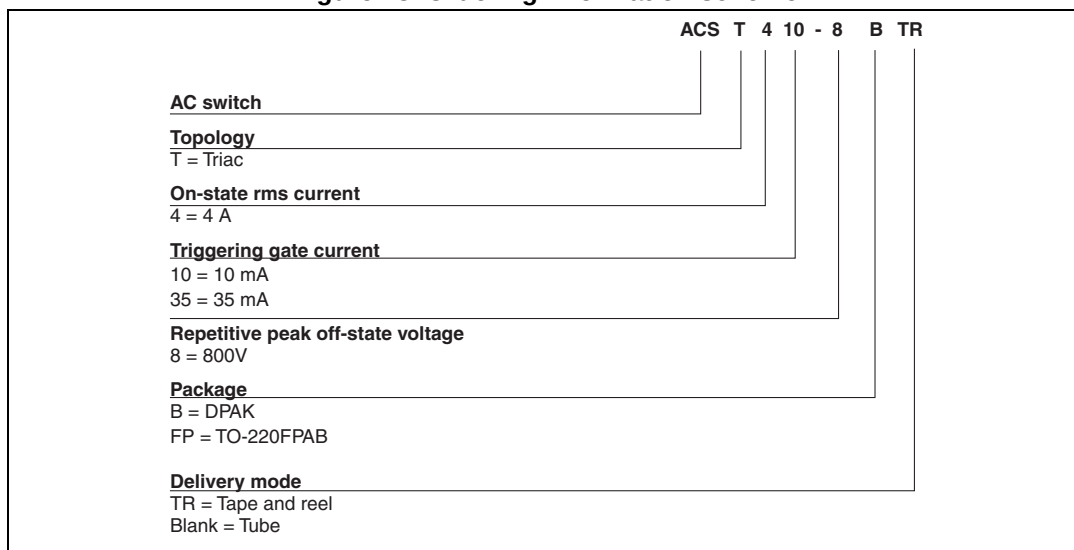


Table 8. Ordering information

Order code	Marking	Package	Weight	Base Qty	Delivery mode
ACST410-8B	ACST4108	DPAK	1.5 g	50	Tube
ACST410-8BTR		DPAK	1.5 g	1000	Tape and reel
ACST410-8FP		TO-220FPAB	2.4 g	50	Tube
ACST435-8B	ACST4358	DPAK	1.5 g	50	Tube
ACST435-8BTR		DPAK	1.5 g	1000	Tape and reel
ACST435-8FP		TO-220FPAB	2.4 g	50	Tube

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
Jan-2003	3A	Previous update.
04-Jul-2007	4	Reformatted to current standard. Added package.
18-Dec-2009	5	V_{DRM}/V_{RRM} updated to 800 V. Order codes updated.
02-Jun-2014	6	Updated DPAK package information and reformatted to current standard.
21-Oct-2014	7	Updated Table 2 , Table 3 , Table 4 , Features and Description .
18-May-2017	8	Updated Features in cover page, Table 2 and Figure 14 .

IMPORTANT NOTICE – PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2017 STMicroelectronics – All rights reserved